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	Spe	cification					
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1.General Specification

The Features is described as follow:

- Module dimension: 54.6 x 42.2 x 1.905 mm
- View area: 50.6 x 31.0 mm
- Active area: 46.577 x 27.697 mm
- LCD type: STN Positive, Yellow Green Reflective
- Duty/ Bias: 1/65 DUTY,1/7BIAS
- View direction: 12 o'clock
- Backlight Type: Without backlight
- IC:ST7565P

Midas LCD Part Number System

МС	COG	132033	Α	*	6	W	*	*	-	S	Ν	т	L	W	*	*
1	2	3	4	5	6	7	8	9	-	10	11	12	13	14	15	16
1	=	MC: Midas (Сотро	nents												
2	=	Blank: COB	chip (on boai	rd) CO	G: chip	on glas	s								
3	=	No of dots		(e.g. 24	40064	= 240 x	64 dot	s)	(e	e.g. 216	05 = 2	x 16 5m	m C.H.)		
4	=	Series														
5	=	Series Varia	nt:	A to Z	– see :	addendı	ım									
6	=	3: 3 o'clock		6: 6 o'	clock	9): 9 o'cl	ock	12	2: 12 o'	clock					
7	=	S: Normal (0 to + 3	50 deg	C) W:	Wide to	emp. (-	20 to +	- 70 de	gC)X:	Exten	ded tem	ıp (-30 -	+ 80 De	g C)	
8	=	Character Se	et													
9	Ξ	Blank 9. 2 8. 3 7. 4 7. 5 9. 6 7 7 7 8 6. 9 6. A 5. B 5. D 6. E 5. F 4.	Simplifi Big 5 (I (std) Japanes n (Eng n (Eng abic t (when t (when	ied (Gra (Graph (Englis se (spec lish/Sca glish/Gr lish/Sca re appli Bezel to f PCB not	aphic I ic Disp sh/Gerr cial) andina reek) andina	Displays olays on man/Fre vian/Ice / availal Con (via an Con Sep Sep Sep Sep Sep Sep Sep Sep Sep Sep	ly) ench/G elandic) An or l An An An An An E. E. E. E. E. E.	rray Edge Lit Tray Tray Tray Tray Tray Tray Tray Tray				Su		ly	
10	=	T: TN S : S1	FN B : \$	STN B	lue G:	STN G	rey F:	FSTN	F2: F	FSTN	V: VAT	TN Z:2	Zero Po	wer (Bi	-Stable)	
11	=	P: Positive	N: Neg	ative												
12	=	R: Reflectiv	те М:Т	ransm	issive	T: Tran	sflectiv	ve.								
13	=	Backlight:	Blank:	Reflect	tive L	: LED										
14	=	Backlight C	olour:	Y: Yel	low-G	reen W	: White	e B: B	lue R :	Red A	: Ambe	er 0: O1	ange G a	Green	RGB: I	R.G.B.
		If Z (Zero P	'ower):	WB: V	White o	on blue	GB: G	reen or	ı black	YB: Y	ellow o	n black	YPB: Y	Yellow	on pink	and/or ł
15	=	Driver Chip:	:	Blank	: Stano	dard I	I I ² C	T: Tos	hiba T	6963C	A: Av	ant SA	P1024B	R: F	taio RA	8835
16	=	Voltage Var	iant: e.	g. 3 = 3	3v											

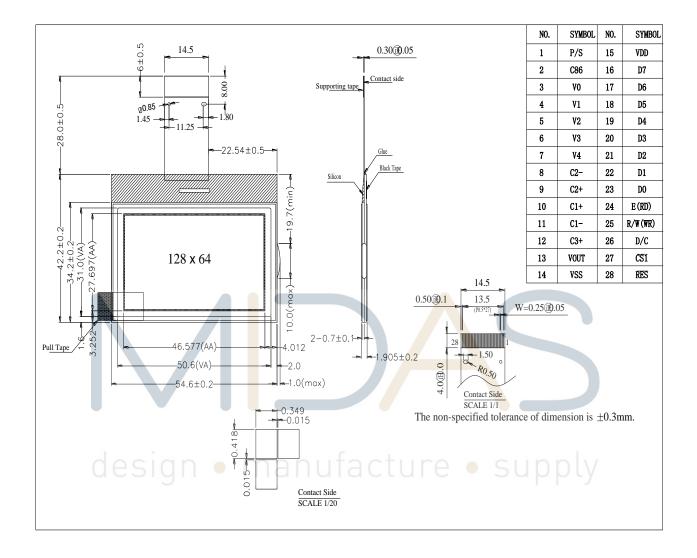
blue

3.Interface Pin Function

Pin No.	Symbol	Description
1	P/S	This pin configures the interface to be parallel mode or serial mode. P/S = "H": Parallel data input/output. P/S = "L": Serial data input.
2	C86	This is the MPU interface selection pin. C86 = "H": 6800 Series MPU interface. C86 = "L": 8080 Series MPU interface.
3	V0	This is a multi-level power supply for the liquid crystal drive. The
4	V1	voltage Supply applied is determined by the liquid crystal cell, and is changed through the use of a resistive voltage divided or
5	V2	throug <mark>h</mark> changing the impedance using an op. amp.
6	V3	Voltage levels are determined based on Vss, and must maintain the relative magnitudes shown below.
7	V4	V0 ≥ V1 ≥ V2 ≥ V3 ≥ V4 ≥ Vss
8	C2-	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP2P terminal
9 0	e S _{C2+} N	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP2N terminal.
10	C1+	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1N terminal.
11	C1-	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1P terminal.
12	C3+	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1N terminal.
13	VOUT	Voltage converter input/output pin Connect this pin to VSS through capacitor.
14	VSS	Ground
15	VDD	Power supply
16	D7	This is an 8-bit bi-directional data bus that connects to an 8-bit or
17	D6	16-bit Standard MPU data bus. When the serial interface (SPI-4) is selected (P/S = "L") :
18	D5	D7 : serial data input (SI) ; D6 : the serial clock input (SCL).

19	D4	D0 to D5 should be connected to VDD or floating.
20	D3	When the chip select is not active, D0 to D7 are set to high impedance.
21	D2	
22	D1	
23	D0	
24	E(/RD)	When connected to 8080 series MPU, this pin is treated as the "/RD" signal of the8080 MPU and is LOW-active. The data bus is in an output status when this signal is "L". When connected to 6800 series MPU, this pin is treated as the "E" signal of the6800 MPU and is HIGH-active.This is the enable clock input terminal of the 6800 Series MPU.
25	R/W(/WR)	When connected to 8080 series MPU, this pin is treated as the "/WR" signal of the8080 MPU and is LOW-active. The signals on the data bus are latched at the rising edge of the /WR signal. When connected to 6800 series MPU, this pin is treated as the "R/W" signal of the6800 MPU and decides the access type : When R/W = "H": Read. When R/W = "L": Write
26	es ^p /gn	This is connect to the least significant bit of the normal MPU address bus, and it determines whether the data bits are data or command.
27	/CS1	This is the chip select signal
28	/RES	When /RES is set to "L", the register settings are initialized (cleared). The reset operation is performed by the /RES signal level.

4.Contour Drawing

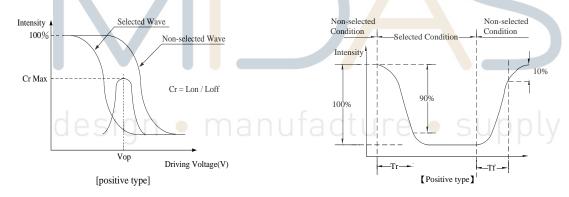


5.Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR≧2	0	_	45	ψ= 180°
	θ	CR≧2	0	—	25	ψ= 0°
View Angle	θ	CR≧2	0	—	35	ψ= 90°
	θ	CR≧2	0	_	35	ψ= 270°
Contrast Ratio	CR		3			
	T rise	_			250	ms
Response Time	T fall	-	-	_	250	ms

Definition of Operation Voltage (Vop)

Definition of Response Time (Tr, Tf)

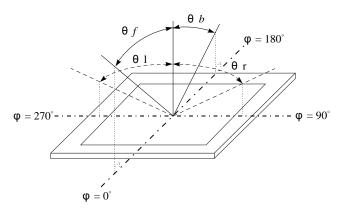


Conditions :

 $\label{eq:operating voltage : Vop} Viewing Angle(\theta \ , \ \phi) : 0^\circ \ , \ 0^\circ$

Frame Frequency : 64 HZ Driving Waveform : 1/N duty , 1/a bias

Definition of viewing angle(CR \geq 2)



6.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T _{OP}	-20	_	+70	°C
Storage Temperature	T _{ST}	-30	_	+80	°C
Power Supply Voltage	VDD	-0.3	_	3.6	V
Power supply voltage (VDD standard)	V0, VOUT	-0.3	_	14.5	V
Power supply voltage (VDD standard)	V1, V2, V3, V4	-0.3	_	V0+0.3	V

7.Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	V_{DD} - V_{SS}	_	3.2	3.3	3.4	V
		Ta=-20 ℃		_		V
Supply Voltage For LCM	V _{OP}	Ta=25 ℃	8.6	8.8	9.0	V
		Ta=70 ℃				V
Supply Current	I _{DD}	V _{DD} =3.3V		0.1		mA

Please kindly consider to design the Vop to be adjustable while programing the software to match LCD contrast tolerance



8.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

	Environmental Test		
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30℃ 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70℃ 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20℃ 200hrs	1
High Temperature/ Humidity storage	The module should be allowed to stand at 60°C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C ,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C	-20℃/ 70 ℃ 10 cycles	
desig Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time	

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

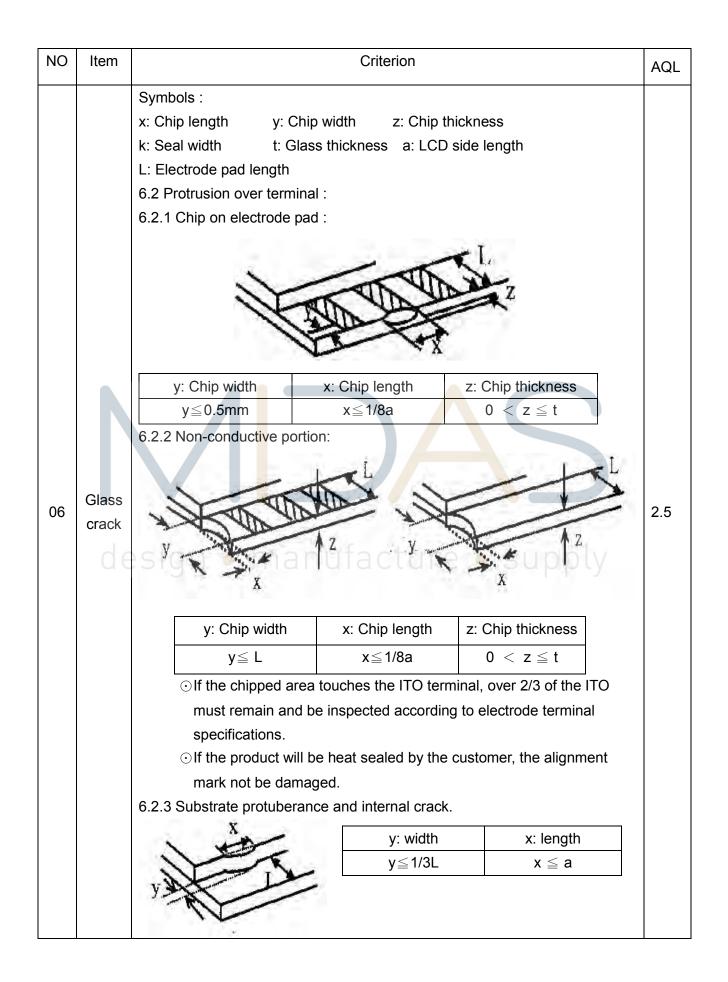
Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

9.Inspection specification

NO	Item			Criterion		AQL
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character , dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 				0.65
02	Black or white spots on LCD (display only)	2.1 White and black spots on display \leq 0.25mm, no more than				2.5
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type $\Phi = (x + y) / $ X	2 ↓ ▼Y	SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$	Acceptable Q TY Accept no dense 2 1 0 Acceptable Q TY Accept no dense 2 As round type	2.5
04	Polarizer bubbles	If bubbles are vi judge using blac specifications, n to find, must che specify direction	ck spot not easy eck in	Size Φ $\Phi \leq 0.20$ $0.20 < \Phi \leq 0.50$ $0.50 < \Phi \leq 1.00$ $1.00 < \Phi$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3 3	2.5

NO	Item		Criterion		AQL
05	Scratches	Follow NO.3 LCD black	spots, white spots, con	tamination	
05	Chipped glass deSi	Symbols Define: x: Chip length y: k: Seal width t: C L: Electrode pad length 6.1 General glass chip 6.1.1 Chip on panel sur C.1.1 Chip on panel sur Z: Chip thickness $Z \le 1/2t$ $1/2t < z \le 2t$	Chip width z: Chip Glass thickness a: LCE	thickness D side length in panels: x: Chip length $x \le 1/8a$	2.5
		z: Chip thickness $Z \le 1/2t$	y: Chip width Not over viewing area	x: Chip length $x \le 1/8a$	
		1/2t <z≦2t< td=""><td>Not exceed 1/3k</td><td>x≦1/8a</td><td></td></z≦2t<>	Not exceed 1/3k	x≦1/8a	
		1/2t <z≦2t< td=""><td>0</td><td>x≦1/8a</td><td></td></z≦2t<>	0	x≦1/8a	



NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB COB	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 10.9 The Scraping testing standard for Copper Coating of PCB X * Y<=2mm2 	 2.5 2.5 0.65 2.5 0.65 2.5 0.65 2.5 2.5 2.5 2.5
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	 2.5 2.5 2.5 0.65

NO	Item	Criterion	AQL
NO 12	Item General appearance	Criterion 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 LCD pin loose or missing pins.	2.5 0.65 2.5 2.5 2.5 2.5 2.5 0.65 0.65
		12.9 ECD pin loose of missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet.	0.65 0.65
	desiq	 12.11 Product dimension and structure must conform to product specification sheet. 12.12 Visual defect outside of VA is not considered to be rejection. 	

10.Precautions in use of LCD Modules

- (1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Midas have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors,capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9)Midas have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Midas have the right to modify the version.)

11.Material List of Components for RoHs

1. Midas hereby declares that all of or part of products (with the mark

"#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm
Above limited value is set up according to BoHS						

Above limited value is set up according to RoHS.

- 2.Process for RoHS requirement :
 - (1) Use the Sn/Ag/Cu soldering surface ; the surface of Pb-free solder is rougher than we used before.
 - (2) Heat-resistance temp. :

Reflow : 250°C,30 seconds Max. : 1 1 a cture • Suppl

Connector soldering wave or hand soldering : 320 $^\circ\!\mathbb{C}$, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5 $^\circ\!\mathrm{C}\,$;

Recommended customer's soldering temp. of connector : 280° C , 3 seconds.

12.Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.

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